TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74HC165AP, TC74HC165AF**

8-Bit Shift Register (P-IN, S-OUT)

The TC74HC165A is a high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock inputs. When the SHIFT/ $\overline{\text{LOAD}}$  input is held high, the serial data input is enabled and the eight frip-frops perform serial shifting with each clock pulse.

When the SHIFT/ LOAD input is held low, the parallel data is loaded asynchronously into the register at positive going transition of the clock pulse.

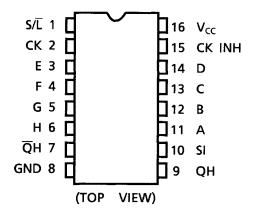
The CK-INH input should be shifted high only when the CK input is held high.

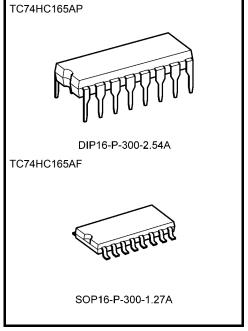
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $f_{max} = 56 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | IOH | = IOL = 4 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS165

#### **Pin Assignment**

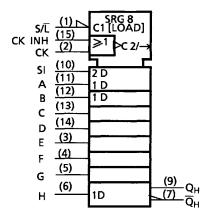




Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

## **IEC Logic Symbol**



### **Truth Table**

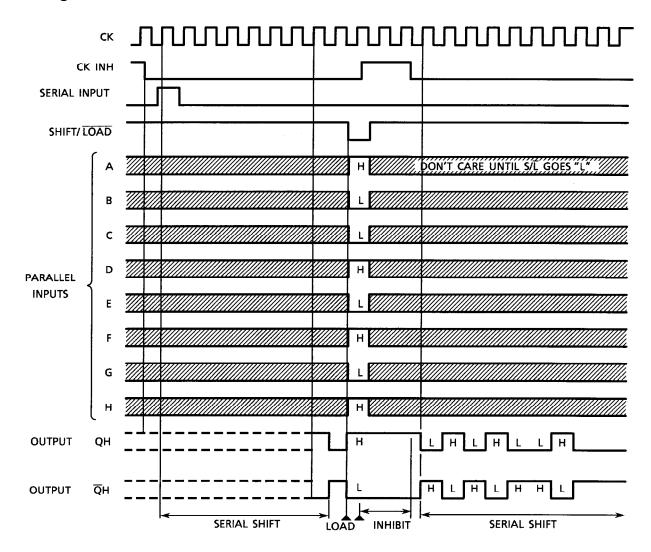
Inputs						Internal Outputs		puts	
SHIFT/ LOAD	CLOCK INH	CLOCK	SERIAL IN	PARALLEL A·····H	QA	QB	QH	QH QH	
L	Х	Х	Х	a·····h	а	b	h	h	
Н	L		Н	Х	Н	QAn	QGn	QGn	
Н	L		L	Х	L	QAn	QGn	QGn	
Н		L	Н	Х	Н	QAn	QGn	QGn	
Н		L	L	Х	L QAn		QGn	QGn	
Н	Х	Н	Х	Х	No Change				
Н	Н	Х	Х	Х	No Change				

X: Don't care

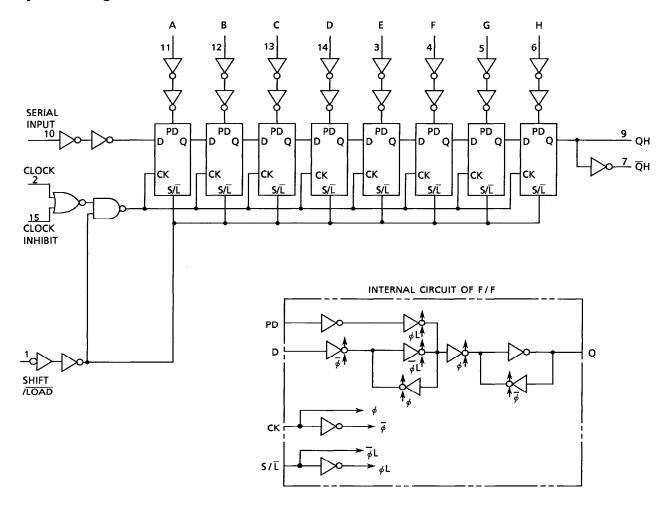
a·····h: The level of steady state input voltage at inputs A through H respectively

QAn~QGn: The level of QA~QG, respectively, before the most recent positive transition of the CK.

## **Timing Chart**



#### **System Diagram**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to  $65^{\circ}C$ . From Ta = 65 to  $85^{\circ}C$  a derating factor of -10 mW/°C shall be applied until 300 mW.



## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	٧
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition $V_{CC}\left(V\right)$		Ta = 25°C			Ta = -40 to 85°C		Unit	
	-,			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	V <sub>IH</sub>			4.5	3.15	_		3.15	_	V
				6.0	4.20	_	_	4.20	—	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	$V_{IL}$	_		4.5	_	_	1.35	_	1.35	V
				6.0		_	1.80	_	1.80	
	V <sub>ОН</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
Ŭ			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0	_	0.0	0.1	_	0.1	V
, and the second			I <sub>OL</sub> = 4 mA	4.5		0.17	0.26		0.33	
			$I_{OL} = 5.2 \text{ mA}$	6.0		0.18	0.26	_	0.33	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	±0.1	ı	±1.0	μΑ
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or	V <sub>IN</sub> = V <sub>CC</sub> or GND		_	_	4.0	_	40.0	μА

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## Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	to an		2.0	_	75	95	
(CK, CK INH)	t <sub>W (H)</sub>	_	4.5	_	15	19	ns
(OR, OR INIT)	t <sub>W (L)</sub>		6.0	_	13	16	
Minimum pulse width			2.0	_	75	95	
(S/L)	t <sub>W (L)</sub>	_	4.5	_	15	19	ns
(S/L)			6.0	_	13	16	
Minimum act un tima			2.0	_	75	95	
Minimum set-up time (PI- $S/\overline{L}$ )	t <sub>s</sub>	_	4.5	_	15	19	ns
(PI- 5/L)			6.0	_	13	16	
Minimum and an disco			2.0	_	75	95	
Minimum set-up time	t <sub>s</sub>	_	4.5	_	15	19	ns
(SI-CK, CK INH)			6.0	_	13	16	
			2.0	_	75	95	
Minimum set-up time	ts	_	4.5	_	15	19	ns
(S/L̄-CK, CK INH)			6.0	_	13	16	
Minimum In all time			2.0	_	0	0	
Minimum hold time	t <sub>h</sub>	_	4.5	_	0	0	ns
(PI- S/L )			6.0	_	0	0	
NAtional and Inc. and Advances			2.0	_	0	0	
Minimum hold time	t <sub>h</sub>	_	4.5	_	0	0	ns
(SI-CK, CK INH)			6.0	_	0	0	
NAIndiana and In a lat Alice a			2.0	_	0	0	
Minimum hold time	t <sub>h</sub>	_	4.5	_	0	0	ns
(S/ $\overline{L}$ -CK, CK INH)			6.0	_	0	0	
Minimum removal time			2.0	_	75	95	
(CK INH-CK)	t <sub>rem</sub>	_	4.5	_	15	19	ns
(CK-CK INH)			6.0	_	13	16	
			2.0	_	7	6	
Clock frequency	f	_	4.5	_	30	24	MHz
			6.0	_	41	28	

# AC Characteristics (C<sub>L</sub> = 15 pF, $V_{CC}$ = 5 V, Ta = 25°C, input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>	_	_	4	8	ns
Propagation delay time (CK, CK INH-QH, QH)	t <sub>pLH</sub>	_	_	15	25	ns
Propagation delay time (S/L̄-QH, Q̄H)	t <sub>pLH</sub>	_	_	15	25	ns
Propagation delay time (H-QH, $\overline{\text{QH}}$ )	t <sub>pLH</sub>	_	_	14	26	ns
Maximum clock frequency	f <sub>max</sub>	_	35	56	_	MHz

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AC Characteristics ( $C_L = 50 \text{ pF}$ , input:  $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol Test Condition				Ta = 25°0		Ta –40 to	Unit	
	- <b>,</b>		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
	4		2.0	_	25	75	_	95	
Output transition time	t <sub>TLH</sub>	_	4.5	_	8	15	_	19	ns
	t <sub>THL</sub>		6.0	_	7	13	_	16	
Propagation delay time	<b>4</b>		2.0	_	55	150	_	190	
_	t <sub>pLH</sub>	_	4.5	_	18	30	_	38	ns
(CK, CK INH-QH, QH)	$t_{pHL}$		6.0	_	15	26	_	33	
Propagation delay time	<b>4</b>		2.0	_	60	165	_	205	
(S/L -QH, QH)	t <sub>pLH</sub>	_	4.5	_	19	33	_	41	ns
(3/L-QH, QH)	t <sub>pHL</sub>		6.0	_	16	28	_	35	
Propagation delay time			2.0	_	52	135	_	170	
(H-QH, QH)	$t_{pHL}$	_	4.5	_	17	27	_	34	ns
(n-Qn, Qn)			6.0	_	14	23	_	29	
			2.0	7	14	_	6	_	
Maximum clock frequency	f <sub>max</sub>	_	4.5	30	46	_	24	_	MHz
oquooy			6.0	41	65	_	28	_	
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	_			55	—	_	_	pF

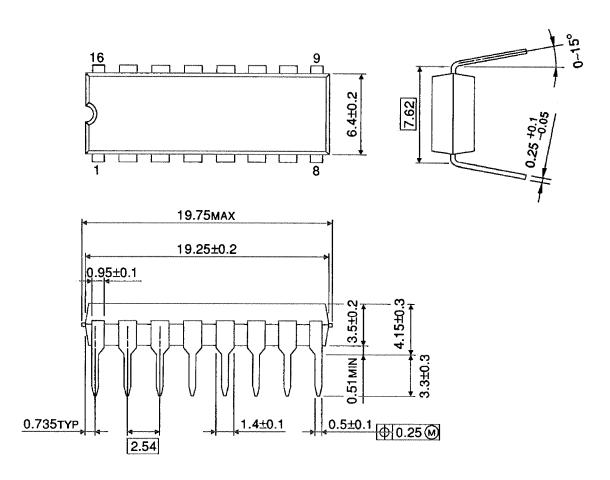
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

## **Package Dimensions**

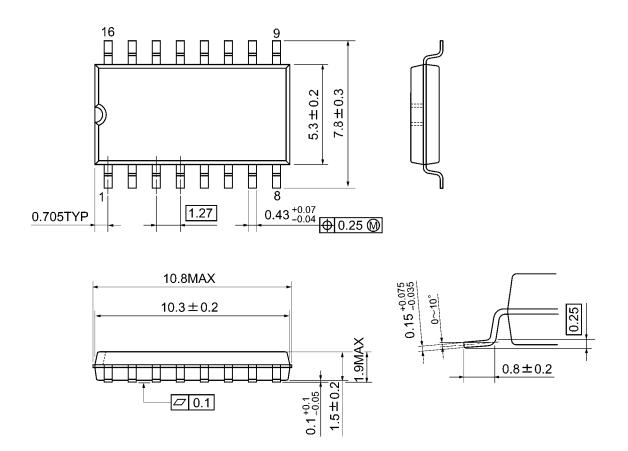
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

## **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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